

HSF

TECHNICAL SPECS:

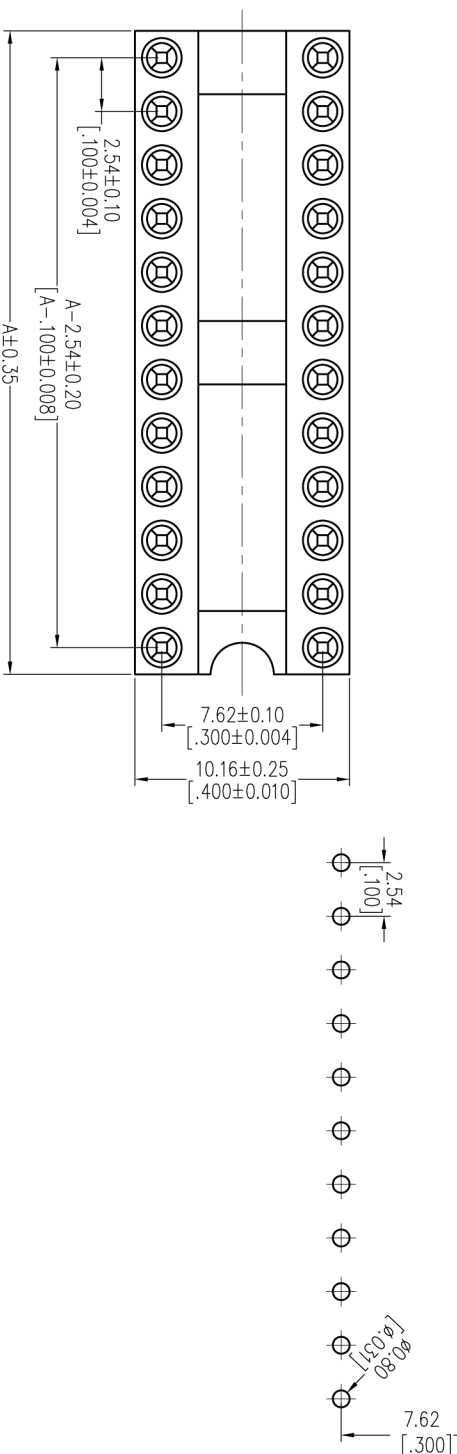
Current Rating: 1.0AMP
Contact Resistance: 10m Ω Max
Dielectric Strength: Min 1000Vrms
Mechanical Life: Min 100 cycles
Mating Pin: $\phi 0.40$ to $\phi 0.56$ mm
Forces: (polished steel gauge $\phi 0.43$ mm)
Insertion: 200g Max/Pin, Withdrawal: 60g Min/Pin
Operation Temperature: -40°C to +105°C

Sleeve: Brass CuZn36Pb3(C36000), Sn over Ni
Contact Clip(4 finger): BeCu(C17200), Au or Sn over Ni
Insulator Material: PPS+30%G.F.(UL94V-0)
06P~18P Insulators without center bar
20P~28P Insulators with center one bar

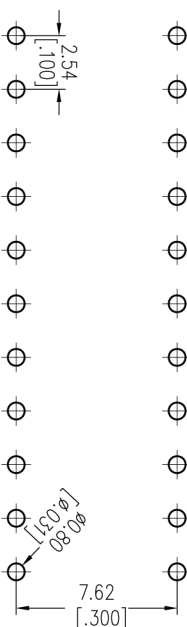
Ordering Information

7110-301 XXS XX074 X1

Row of Pitch No. of Pin Contact Plating Packing
l=7.62mm See tab S0=Gold Flash/Tin T=Tube
S3=10u"Gold/Tin A=Tray
S4=15u"Gold/Tin S5=30u"Gold/Tin
SN=Tin



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Dimensional & Ordering Information

NO. of Poles	Part No.	Dim A
06	7110-30106SXX074X1	7.62
08	7110-30108SXX074X1	10.16
10	7110-30110SXX074X1	12.70
14	7110-30114SXX074X1	17.78
16	7110-30116SXX074X1	20.32
18	7110-30118SXX074X1	22.86
20	7110-30120SXX074X1	25.40
22	7110-30122SXX074X1	27.94
24	7110-30124SXX074X1	30.48
28	7110-30128SXX074X1	35.56



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REV	DATE	MODIFICATION DESCRIPTION
A0	2012/11/02	NEW

OPERATION	DRAW	DATE	SCALE	FIT
XX ±0.40	JYhuang	2012/11/02	UNIT	mm
XXX ±0.25	CHECK	DATE	SIZE	A4
XXXX ±0.15	APPROVE	DATE	SHEET	1/1
Angle ± 3'	CHANGE		PROJ.	☉
DIM	TOL			

PART NO.	SEE TAB
TITLE: IC SOCKET 180° H=3.0 L=7.43	
2.54mm Row of Pitch 7.62	
Customer NO.	